74AUP1G79

Low-power D-type flip-flop; positive-edge trigger

Rev. 8 — 24 January 2022 Product data sheet

1. General description

The 74AUP1G79 is a single positive-edge triggered D-type flip-flop. Data at the D-input that meets the set-up and hold time requirements on the LOW-to-HIGH clock transition will be stored in the flip-flop and appear at the Q output.. Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times. This device ensures very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V. This device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- CMOS low power dissipation
- High noise immunity
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-C (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; I_{CC} = 0.9 μA (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Overvoltage tolerant inputs to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

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3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AUP1G79GW	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74AUP1G79GV	-40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753
74AUP1G79GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74AUP1G79GN	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm	SOT1115
74AUP1G79GS	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm	SOT1202
74AUP1G79GX	-40 °C to +125 °C	X2SON5	plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 × 0.8 × 0.32 mm	SOT1226-3

4. Marking

Table 2. Marking

Type number	Marking code [1]
74AUP1G79GW	pP
74AUP1G79GV	p79
74AUP1G79GM	pP
74AUP1G79GN	pP
74AUP1G79GS	pP
74AUP1G79GX	pP

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

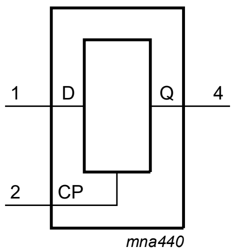


Fig. 1. Logic symbol

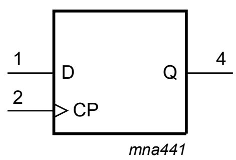


Fig. 2. IEC logic symbol

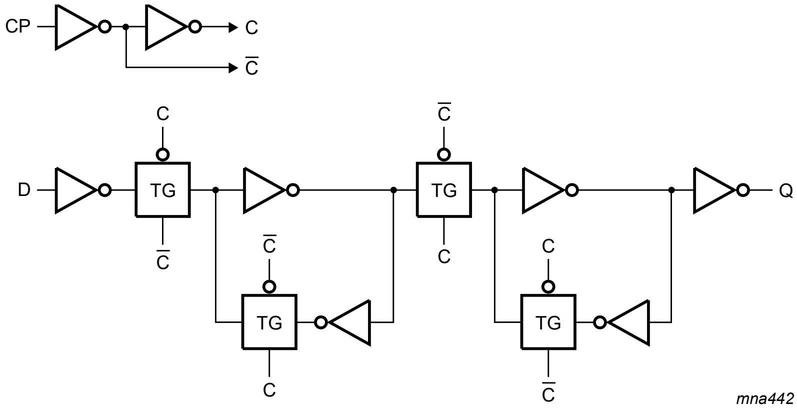


Fig. 3. Logic diagram

6. Pinning information

6.1. Pinning

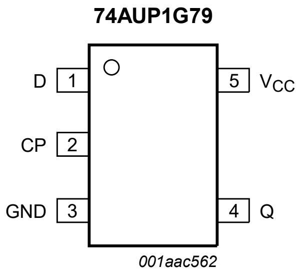


Fig. 4. Pin configuration SOT353-1 (TSSOP5) and SOT753 (SC-74A)

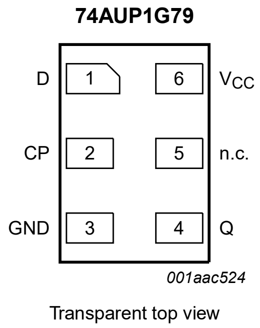


Fig. 5. Pin configuration SOT886 (XSON6)

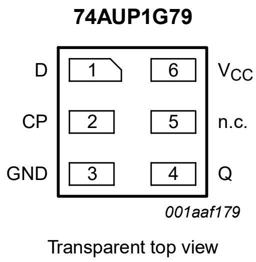


Fig. 6. Pin configuration SOT1115 and SOT1202 (XSON6)

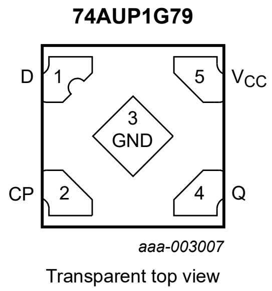


Fig. 7. Pin configuration SOT1226-3 (X2SON5)

6.2. Pin description

Table 3. Pin description

Symbol	Pin		Description
	TSSOP5 and X2SON5	XSON6	
D	1	1	data input
CP	2	2	clock pulse input
GND	3	3	ground (0 V)
Q	4	4	data output
n.c.	-	5	not connected
V_{CC}	5	6	supply voltage

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; ↑ = LOW-to-HIGH CP transition; X = don't care;
q = lower case letter indicates the state of referenced input, one setup time prior to the LOW-to-HIGH CP transition.

Input		Output
CP	D	Q
↑	L	L
↑	H	H
L	X	q

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
I_{IK}	input clamping current	$V_I < 0$ V	-50	-	mA
V_I	input voltage	[1]	-0.5	+4.6	V
I_{OK}	output clamping current	$V_O < 0$ V	-50	-	mA
V_O	output voltage	Active mode and Power-down mode [1]	-0.5	+4.6	V
I_O	output current	V_O = 0 V to V_{CC}	-	±20	mA
I_{CC}	supply current		-	50	mA
I_{GND}	ground current		-50	-	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C [2]	-	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] For SOT353-1 (TSSOP5) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT753 (SC-74A) package: P_{tot} derates linearly with 3.8 mW/K above 85 °C.
For SOT886 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT1115 (XSON6) package: P_{tot} derates linearly with 3.2 mW/K above 71 °C.
For SOT1202 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT1226-3 (X2SON5) package: P_{tot} derates linearly with 3.0 mW/K above 67 °C.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		0.8	3.6	V
V_I	input voltage		0	3.6	V
V_O	output voltage	Active mode	0	V_{CC}	V
		Power-down mode; V_{CC} = 0 V	0	3.6	V
T_{amb}	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V_{CC} = 0.8 V to 3.6 V	0	200	ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 0.8 V	0.70 × V_{CC}	-	-	V
		V_{CC} = 0.9 V to 1.95 V	0.65 × V_{CC}	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V	2.0	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 0.8 V	-	-	0.30 × V_{CC}	V
		V_{CC} = 0.9 V to 1.95 V	-	-	0.35 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V	-	-	0.9	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}				
		I_O = -20 μA; V_{CC} = 0.8 V to 3.6 V	V_{CC} - 0.1	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V	0.75 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V	1.11	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V	1.32	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V	2.05	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V	1.9	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V	2.72	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V	2.6	-	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}				
		I_O = 20 μA; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I_O = 1.1 mA; V_{CC} = 1.1 V	-	-	0.3 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V	-	-	0.31	V
		I_O = 1.9 mA; V_{CC} = 1.65 V	-	-	0.31	V
		I_O = 2.3 mA; V_{CC} = 2.3 V	-	-	0.31	V
		I_O = 3.1 mA; V_{CC} = 2.3 V	-	-	0.44	V
		I_O = 2.7 mA; V_{CC} = 3.0 V	-	-	0.31	V
		I_O = 4.0 mA; V_{CC} = 3.0 V	-	-	0.44	V

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V		-	-	±0.1	μA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V		-	-	±0.2	μA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V		-	-	±0.2	μA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V		-	-	0.5	μA
ΔI_{CC}	additional supply current	per pin; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	[1]	-	-	40	μA
C_I	input capacitance	V_{CC} = 0 V to 3.6 V; V_I = GND or V_{CC}		-	0.8	-	pF
C_O	output capacitance	V_O = GND; V_{CC} = 0 V		-	1.7	-	pF
T_{amb} = -40 °C to +85 °C							
V_{IH}	HIGH-level input voltage	V_{CC} = 0.8 V		0.70 × V_{CC}	-	-	V
		V_{CC} = 0.9 V to 1.95 V		0.65 × V_{CC}	-	-	V
		V_{CC} = 2.3 V to 2.7 V		1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V		2.0	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 0.8 V		-	-	0.30 × V_{CC}	V
		V_{CC} = 0.9 V to 1.95 V		-	-	0.35 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V		-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V		-	-	0.9	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}					
		I_O = -20 μA; V_{CC} = 0.8 V to 3.6 V		V_{CC} - 0.1	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V		0.7 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V		1.03	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V		1.30	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V		1.97	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V		1.85	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V		2.67	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V		2.55	-	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}					
		I_O = 20 μA; V_{CC} = 0.8 V to 3.6 V		-	-	0.1	V
		I_O = 1.1 mA; V_{CC} = 1.1 V		-	-	0.3 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V		-	-	0.37	V
		I_O = 1.9 mA; V_{CC} = 1.65 V		-	-	0.35	V
		I_O = 2.3 mA; V_{CC} = 2.3 V		-	-	0.33	V
		I_O = 3.1 mA; V_{CC} = 2.3 V		-	-	0.45	V
		I_O = 2.7 mA; V_{CC} = 3.0 V		-	-	0.33	V
		I_O = 4.0 mA; V_{CC} = 3.0 V		-	-	0.45	V

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V		-	-	±0.5	μA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V		-	-	±0.5	μA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V		-	-	±0.6	μA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V		-	-	0.9	μA
ΔI_{CC}	additional supply current	per pin; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	[1]	-	-	50	μA
T_{amb} = -40 °C to +125 °C							
V_{IH}	HIGH-level input voltage	V_{CC} = 0.8 V		0.75 × V_{CC}	-	-	V
		V_{CC} = 0.9 V to 1.95 V		0.70 × V_{CC}	-	-	V
		V_{CC} = 2.3 V to 2.7 V		1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V		2.0	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 0.8 V		-	-	0.25 × V_{CC}	V
		V_{CC} = 0.9 V to 1.95 V		-	-	0.30 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V		-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V		-	-	0.9	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}					
		I_O = -20 μA; V_{CC} = 0.8 V to 3.6 V		V_{CC} - 0.11	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V		0.6 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V		0.93	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V		1.17	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V		1.77	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V		1.67	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V		2.40	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V		2.30	-	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}					
		I_O = 20 μA; V_{CC} = 0.8 V to 3.6 V		-	-	0.11	V
		I_O = 1.1 mA; V_{CC} = 1.1 V		-	-	0.33 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V		-	-	0.41	V
		I_O = 1.9 mA; V_{CC} = 1.65 V		-	-	0.39	V
		I_O = 2.3 mA; V_{CC} = 2.3 V		-	-	0.36	V
		I_O = 3.1 mA; V_{CC} = 2.3 V		-	-	0.50	V
		I_O = 2.7 mA; V_{CC} = 3.0 V		-	-	0.36	V
		I_O = 4.0 mA; V_{CC} = 3.0 V		-	-	0.50	V
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V		-	-	±0.75	μA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V		-	-	±0.75	μA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V		-	-	±0.75	μA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V		-	-	1.4	μA
ΔI_{CC}	additional supply current	per pin; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	[1]	-	-	75	μA

[1] One input at V_{CC} - 0.6 V, other input at V_{CC} or GND.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 10.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	Min	Max	
C_L = 5 pF										
t_{pd}	propagation delay	CP to Q; see Fig. 8 [2]								
		V_{CC} = 0.8 V	-	19.7	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.6	5.5	11.0	2.4	12.9	2.4	14.2	ns
		V_{CC} = 1.4 V to 1.6 V	2.0	3.8	7.0	1.8	8.1	1.8	9.0	ns
		V_{CC} = 1.65 V to 1.95 V	1.7	3.1	5.4	1.5	6.4	1.5	7.1	ns
		V_{CC} = 2.3 V to 2.7 V	1.4	2.3	4.0	1.1	4.7	1.1	5.2	ns
		V_{CC} = 3.0 V to 3.6 V	1.2	2.0	3.4	0.9	4.0	0.9	4.4	ns
f_{max}	maximum frequency	CP; see Fig. 9								
		V_{CC} = 0.8 V	-	53	-	-	-	-	-	MHz
		V_{CC} = 1.1 V to 1.3 V	-	203	-	170	-	170	-	MHz
		V_{CC} = 1.4 V to 1.6 V	-	347	-	310	-	300	-	MHz
		V_{CC} = 1.65 V to 1.95 V	-	435	-	400	-	390	-	MHz
		V_{CC} = 2.3 V to 2.7 V	-	550	-	490	-	480	-	MHz
		V_{CC} = 3.0 V to 3.6 V	-	619	-	550	-	510	-	MHz
C_L = 10 pF										
t_{pd}	propagation delay	CP to Q; see Fig. 8 [2]								
		V_{CC} = 0.8 V	-	23.1	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.1	6.3	12.3	2.8	14.4	2.8	15.9	ns
		V_{CC} = 1.4 V to 1.6 V	2.5	4.4	8.1	2.2	9.5	2.2	10.5	ns
		V_{CC} = 1.65 V to 1.95 V	2.1	3.6	6.3	1.9	7.5	1.9	8.3	ns
		V_{CC} = 2.3 V to 2.7 V	1.8	2.8	4.7	1.5	5.6	1.5	6.2	ns
		V_{CC} = 3.0 V to 3.6 V	1.7	2.5	4.1	1.3	4.5	1.3	5.0	ns
f_{max}	maximum frequency	CP; see Fig. 9								
		V_{CC} = 0.8 V	-	52	-	-	-	-	-	MHz
		V_{CC} = 1.1 V to 1.3 V	-	192	-	150	-	150	-	MHz
		V_{CC} = 1.4 V to 1.6 V	-	324	-	280	-	230	-	MHz
		V_{CC} = 1.65 V to 1.95 V	-	421	-	310	-	250	-	MHz
		V_{CC} = 2.3 V to 2.7 V	-	486	-	370	-	360	-	MHz
		V_{CC} = 3.0 V to 3.6 V	-	550	-	410	-	360	-	MHz
C_L = 15 pF										
t_{pd}	propagation delay	CP to Q; see Fig. 8 [2]								
		V_{CC} = 0.8 V	-	26.6	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.5	7.1	13.6	3.2	15.6	3.2	17.2	ns
		V_{CC} = 1.4 V to 1.6 V	2.8	5.0	9.2	2.5	10.7	2.5	11.8	ns
		V_{CC} = 1.65 V to 1.95 V	2.4	4.1	7.1	2.2	8.5	2.2	9.4	ns
		V_{CC} = 2.3 V to 2.7 V	2.2	3.2	5.4	1.9	6.3	1.9	7.0	ns
		V_{CC} = 3.0 V to 3.6 V	2.0	2.9	4.5	1.6	5.0	1.6	5.5	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	Min	Max	
f_{max}	maximum frequency	CP; see Fig. 9								
		V_{CC} = 0.8 V	-	50	-	-	-	-	-	MHz
		V_{CC} = 1.1 V to 1.3 V	-	181	-	120	-	120	-	MHz
		V_{CC} = 1.4 V to 1.6 V	-	301	-	190	-	160	-	MHz
		V_{CC} = 1.65 V to 1.95 V	-	407	-	240	-	190	-	MHz
		V_{CC} = 2.3 V to 2.7 V	-	422	-	300	-	270	-	MHz
		V_{CC} = 3.0 V to 3.6 V	-	481	-	320	-	300	-	MHz
C_L = 30 pF										
t_{pd}	propagation delay	CP to Q; see Fig. 8 [2]								
		V_{CC} = 0.8 V	-	36.8	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	4.7	9.3	17.3	4.2	23.3	4.2	25.6	ns
		V_{CC} = 1.4 V to 1.6 V	3.8	6.4	11.8	3.3	14.3	3.3	15.7	ns
		V_{CC} = 1.65 V to 1.95 V	3.3	5.3	9.4	3.0	11.3	3.0	12.4	ns
		V_{CC} = 2.3 V to 2.7 V	3.0	4.3	7.0	2.7	8.5	2.7	9.4	ns
		V_{CC} = 3.0 V to 3.6 V	2.8	3.9	5.8	2.6	7.2	2.6	7.9	ns
f_{max}	maximum frequency	CP; see Fig. 9								
		V_{CC} = 0.8 V	-	28	-	-	-	-	-	MHz
		V_{CC} = 1.1 V to 1.3 V	-	128	-	70	-	70	-	MHz
		V_{CC} = 1.4 V to 1.6 V	-	206	-	120	-	110	-	MHz
		V_{CC} = 1.65 V to 1.95 V	-	262	-	150	-	120	-	MHz
		V_{CC} = 2.3 V to 2.7 V	-	269	-	190	-	170	-	MHz
		V_{CC} = 3.0 V to 3.6 V	-	309	-	200	-	190	-	MHz
C_L = 5 pF, 10 pF, 15 pF and 30 pF										
t_{su}	set-up time	HIGH; D to CP; see Fig. 9								
		V_{CC} = 0.8 V	-	3.4	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	-	0.8	-	1.6	-	1.4	-	ns
		V_{CC} = 1.4 V to 1.6 V	-	0.5	-	1.0	-	1.0	-	ns
		V_{CC} = 1.65 V to 1.95 V	-	0.5	-	0.9	-	0.9	-	ns
		V_{CC} = 2.3 V to 2.7 V	-	0.4	-	0.7	-	0.7	-	ns
		V_{CC} = 3.0 V to 3.6 V	-	0.4	-	0.6	-	0.6	-	ns
		LOW; D to CP; see Fig. 9								
		V_{CC} = 0.8 V	-	3.0	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	-	0.9	-	1.4	-	1.4	-	ns
		V_{CC} = 1.4 V to 1.6 V	-	0.6	-	1.0	-	1.0	-	ns
		V_{CC} = 1.65 V to 1.95 V	-	0.5	-	0.9	-	0.9	-	ns
		V_{CC} = 2.3 V to 2.7 V	-	0.5	-	0.8	-	0.8	-	ns
		V_{CC} = 3.0 V to 3.6 V	-	0.7	-	1.0	-	1.0	-	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	Min	Max	
t_h	hold time	D to CP; see Fig. 9								
		V_{CC} = 0.8 V	-	-1.9	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	-	-0.6	-	0.2	-	0.2	-	ns
		V_{CC} = 1.4 V to 1.6 V	-	-0.4	-	0	-	0	-	ns
		V_{CC} = 1.65 V to 1.95 V	-	-0.4	-	0	-	0	-	ns
		V_{CC} = 2.3 V to 2.7 V	-	-0.4	-	0	-	0	-	ns
		V_{CC} = 3.0 V to 3.6 V	-	-0.3	-	0	-	0	-	ns
t_W	pulse width	HIGH or LOW; CP; see Fig. 9								
		V_{CC} = 0.8 V	-	5.6	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	-	2.4	-	3.5	-	3.5	-	ns
		V_{CC} = 1.4 V to 1.6 V	-	1.3	-	2.0	-	2.0	-	ns
		V_{CC} = 1.65 V to 1.95 V	-	0.9	-	1.9	-	1.9	-	ns
		V_{CC} = 2.3 V to 2.7 V	-	0.7	-	2.0	-	2.0	-	ns
		V_{CC} = 3.0 V to 3.6 V	-	0.6	-	2.2	-	2.2	-	ns
C_{PD}	power dissipation capacitance	f_i = 1 MHz; V_I = GND to V_{CC} [3]								
		V_{CC} = 0.8 V	-	1.6	-	-	-	-	-	pF
		V_{CC} = 1.1 V to 1.3 V	-	1.7	-	-	-	-	-	pF
		V_{CC} = 1.4 V to 1.6 V	-	1.8	-	-	-	-	-	pF
		V_{CC} = 1.65 V to 1.95 V	-	1.9	-	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	2.3	-	-	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V	-	2.7	-	-	-	-	-	pF

[1] All typical values are measured at nominal V_{CC}.

[2] t_{pd} is the same as t_{PLH} and t_{PHL}.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}{}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

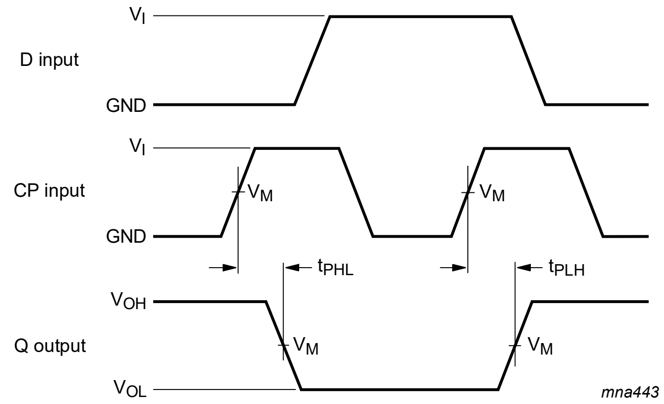
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

$\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

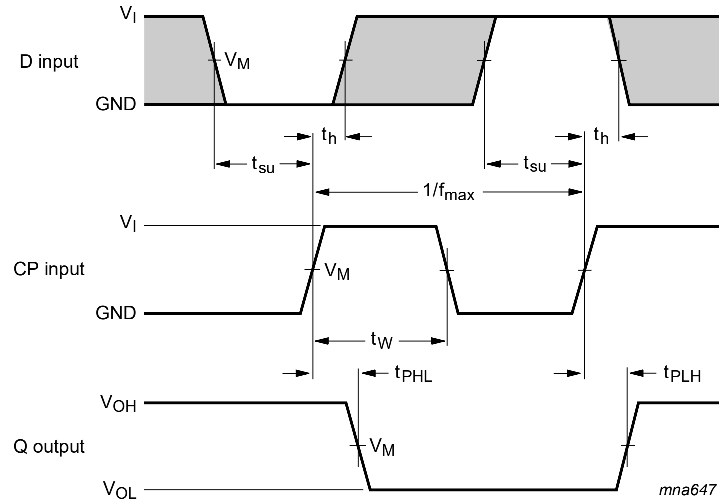
11.1. Waveforms and test circuit



Measurement points are given in Table 9.

Logic levels: V_{OL} and V_{OH} are typical output voltage drops that occur with the output load.

Fig. 8. The clock input (CP) to output (Q) propagation delays



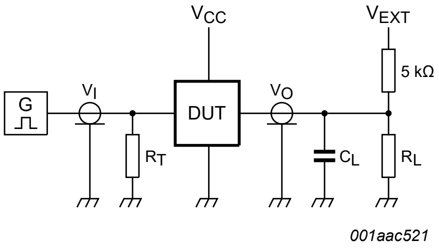
Measurement points are given in Table 9.

Logic levels: V_{OL} and V_{OH} are typical output voltage drops that occur with the output load.

Fig. 9. The clock input (CP) to output (Q) propagation delays, CP clock pulse width, D to CP setup times, CP to D hold times and the CP maximum frequency

Table 9. Measurement points

Supply voltage	Output	Input		
V_{CC}	V_M	V_M	V_I	$t_r = t_f$
0.8 V to 3.6 V	0.5 × V_{CC}	0.5 × V_{CC}	V_{CC}	≤ 3.0 ns



Test data is given in Table 10.
Definitions for test circuit:
R_L = Load resistance;
C_L = Load capacitance including jig and probe capacitance;
R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator;
V_{EXT} = External voltage for measuring switching times.

Fig. 10. Test circuit for measuring switching times

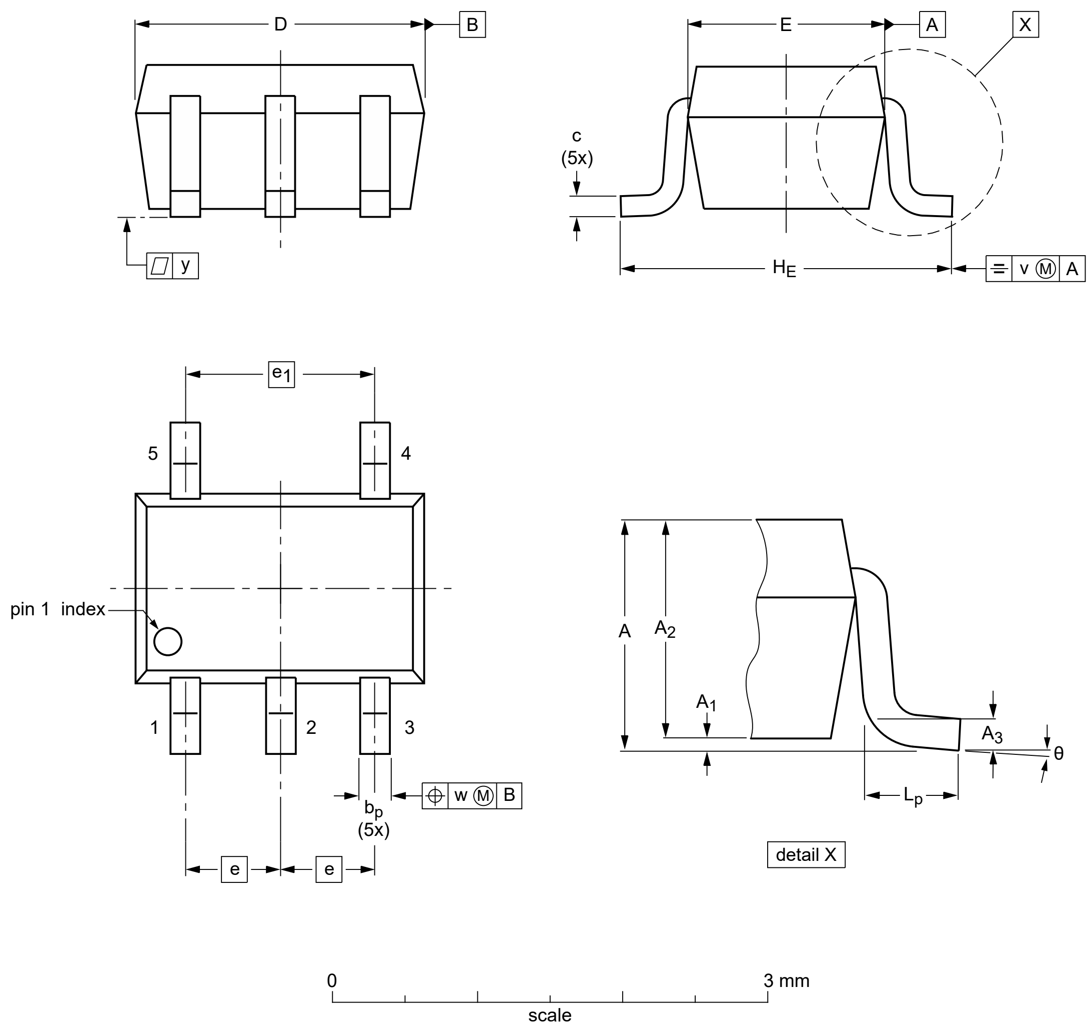
Table 10. Test data

Supply voltage	Load		V_{EXT}		
V_{CC}	C_L	R_L [1]	t_{PLH}, t_{PHL}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	2 × V_{CC}

[1] For measuring enable and disable times R_L = 5 kΩ.
For measuring propagation delays, setup and hold times and pulse width R_L = 1 MΩ.

12. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm **SOT353-1**



Dimensions (mm are the original dimensions)

Unit		A	A_1	A_2	A_3	b_p	c	D(1)	E(1)	e	e_1	H_E	L_p	v	w	y	θ
mm	max	1.1	0.1	1.0	0.15	0.30	0.25	2.2	1.35	0.65	1.3	2.4	0.46	0.3	0.1	0.1	8°
	min	0.8	0	0.8		0.15	0.08	1.8	1.15			1.8	0.26				0°

Note

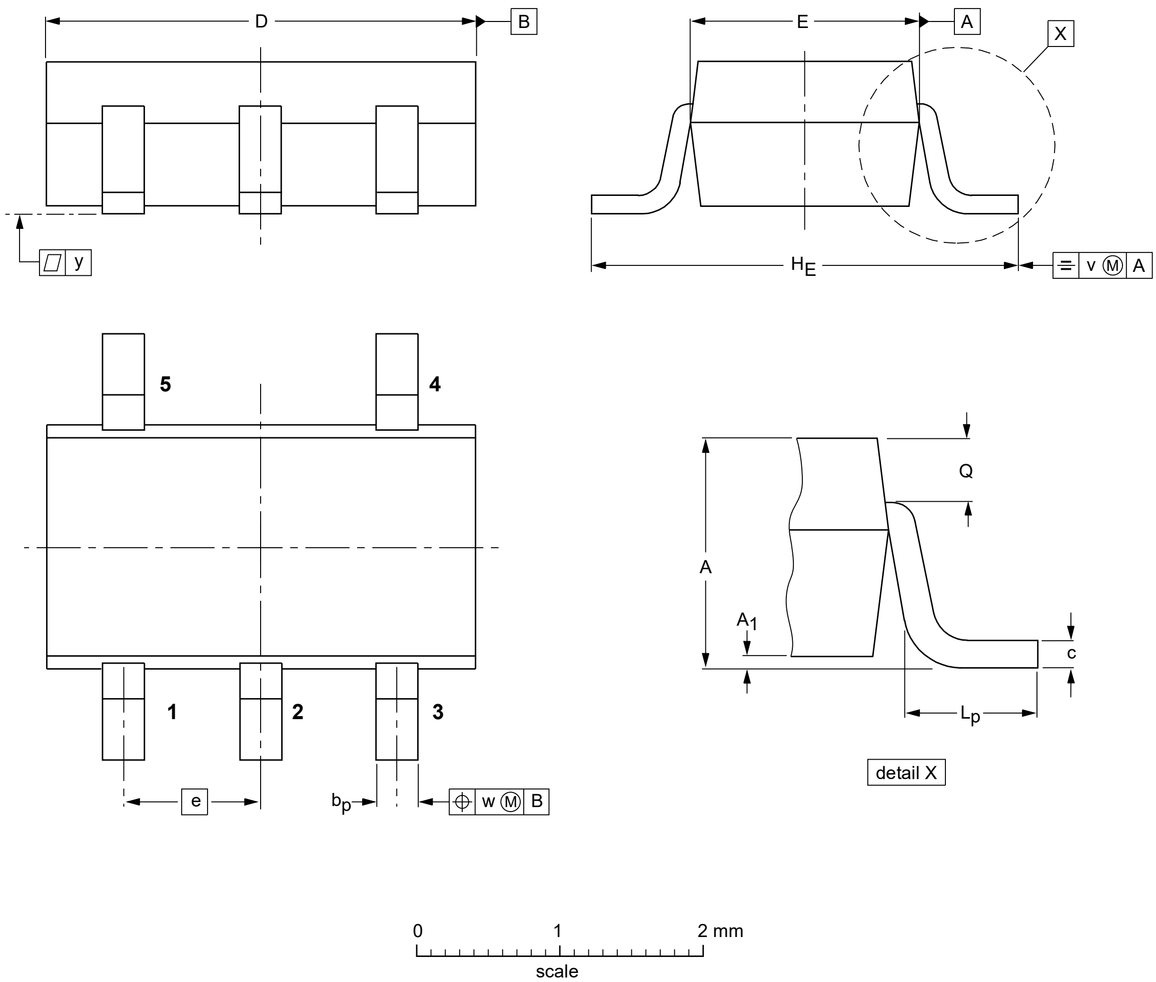
1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

sot353-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT353-1		MO-203	SC-88A			~~21-12-15~~ 21-12-16

Fig. 11. Package outline SOT353-1 (TSSOP5)

Plastic surface-mounted package; 5 leads **SOT753**



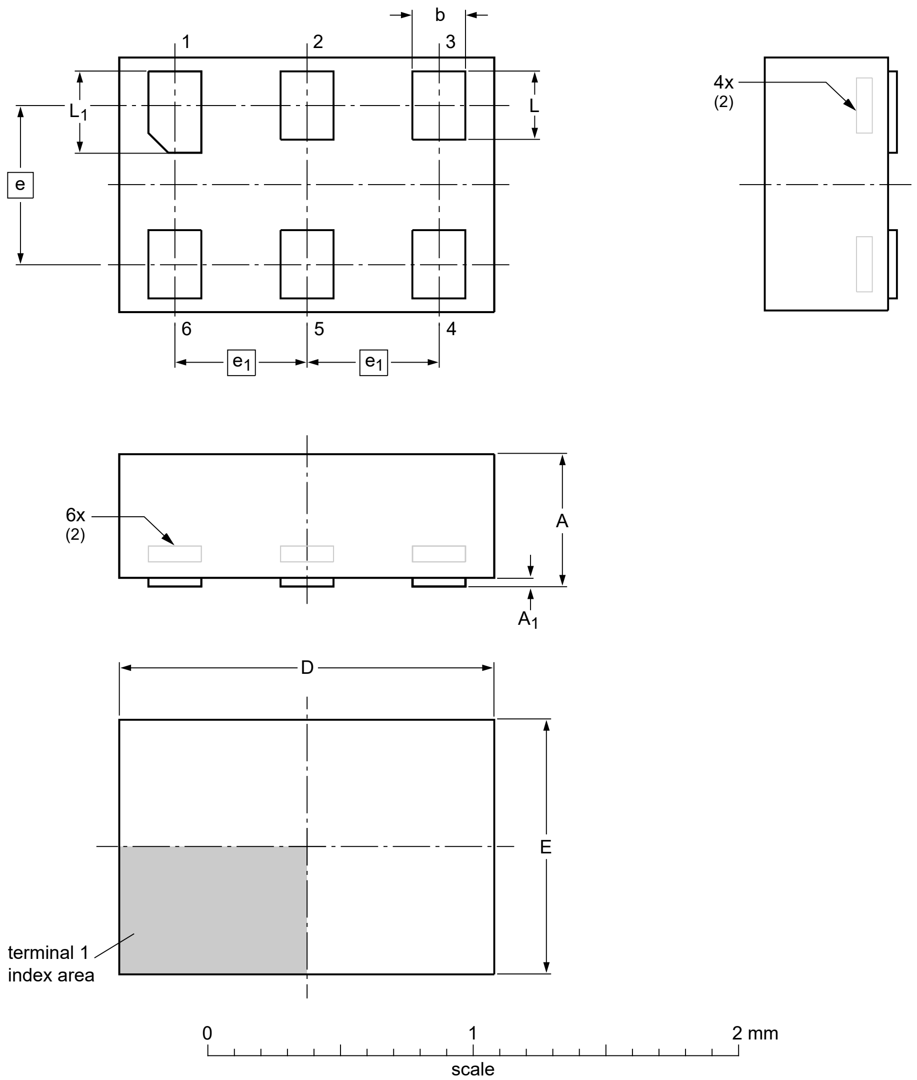
DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1	b_p	c	D	E	e	H_E	L_p	Q	v	w	y
mm	1.1 0.9	0.100 0.013	0.40 0.25	0.26 0.10	3.1 2.7	1.7 1.3	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT753			SC-74A			~~02-04-16~~ 06-03-16

Fig. 12. Package outline SOT753 (SC-74A)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm SOT886



Dimensions (mm are the original dimensions)

Unit		A(1)	A_1	b	D	E	e	e_1	L	L_1
	max	0.5	0.04	0.25	1.50	1.05			0.35	0.40
mm	nom			0.20	1.45	1.00	0.6	0.5	0.30	0.35
	min			0.17	1.40	0.95			0.27	0.32

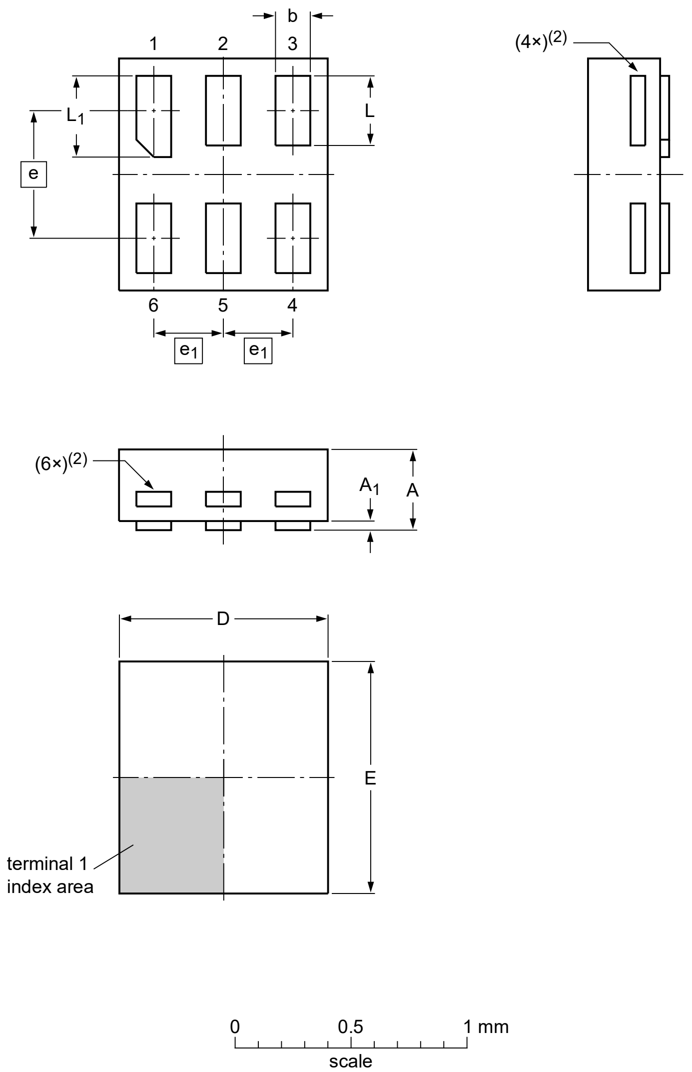
Notes
1. Including plating thickness.
2. Can be visible in some manufacturing processes.

sot886_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT886		MO-252				~~04-07-22~~ 12-01-05

Fig. 13. Package outline SOT886 (XSON6)

XSON6: extremely thin small outline package; no leads;
6 terminals; body 0.9 x 1.0 x 0.35 mm **SOT1115**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
	max	0.35	0.04	0.20	0.95	1.05			0.35	0.40
mm	nom			0.15	0.90	1.00	0.55	0.3	0.30	0.35
	min			0.12	0.85	0.95			0.27	0.32

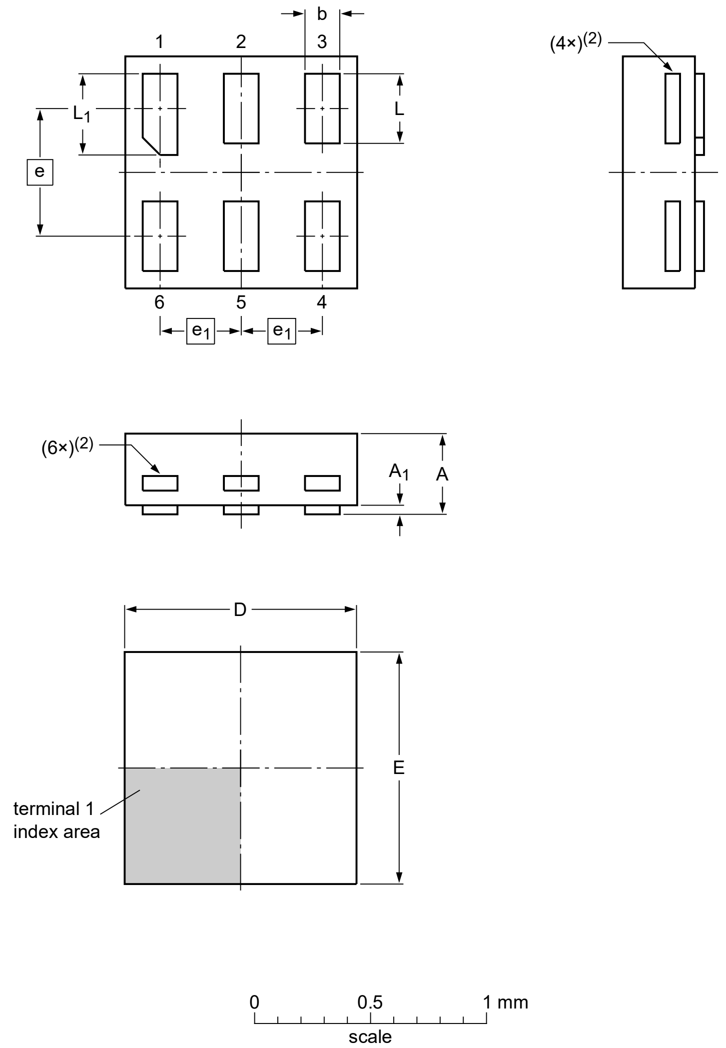
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1115_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1115						~~10-04-02~~ 10-04-07

Fig. 14. Package outline SOT1115 (XSON6)

XSON6: extremely thin small outline package; no leads;
6 terminals; body 1.0 x 1.0 x 0.35 mm **SOT1202**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
	max	0.35	0.04	0.20	1.05	1.05			0.35	0.40
mm	nom			0.15	1.00	1.00	0.55	0.35	0.30	0.35
	min			0.12	0.95	0.95			0.27	0.32

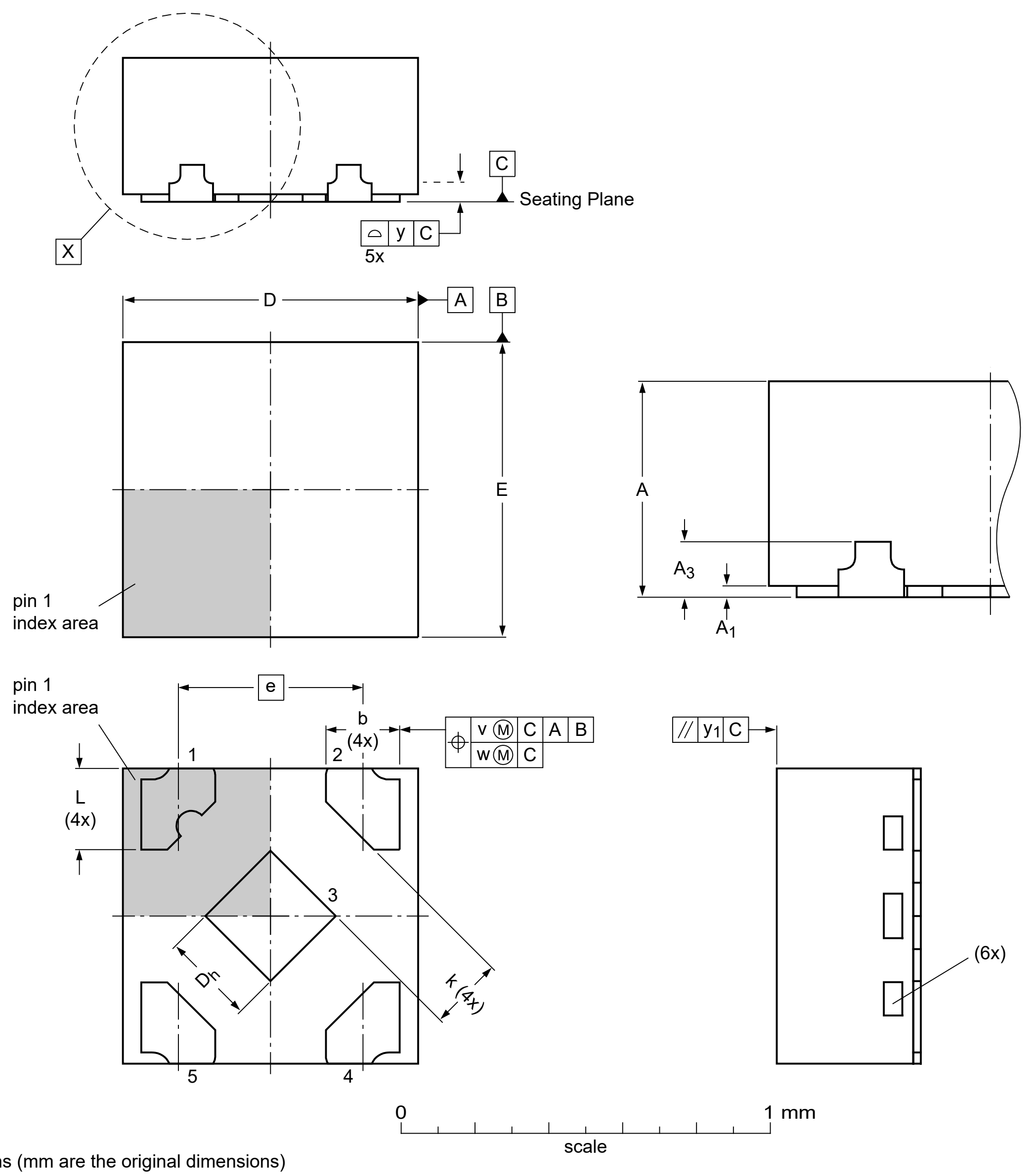
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1202_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1202						~~10-04-02~~ 10-04-06

Fig. 15. Package outline SOT1202 (XSON6)

X2SON5: plastic thermal enhanced extremely thin small outline package; no leads;
5 terminals; body 0.8 x 0.8 x 0.32 mm **SOT1226-3**



Dimensions (mm are the original dimensions)

Unit		A	A_1	A_3	D	D_h	E	b	e	K	L	v	w	y	y_1
mm	max	0.35	0.04	0.10 (Typ.)	0.85	0.30	0.85	0.25			0.27				
	nom	0.32	0.02		0.80	0.25	0.80	0.20	0.50		0.22	0.1	0.05	0.05	0.05
	min	0.30	0.00		0.75	0.20	0.75	0.15		0.20	0.17				

sot1226-3_po

Outline version	References: IEC	References: JEDEC	References: EIAJ		European projection	Issue date
SOT1226-3		- - -				~~19-11-06~~ 19-11-07

Fig. 16. Package outline SOT1226-3 (X2SON5)

13. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1G79 v.8	20220124	Product data sheet	-	74AUP1G79 v.7
Modifications:	• Fig. 11: Package outline drawing for SOT353-1 has changed.			
74AUP1G79 v.7	20210720	Product data sheet	-	74AUP1G79 v.6
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • SOT1226 (X2SON5) package changed to SOT1226-3 (X2SON5) package. • Type number 74AUP1G79GF (SOT891/XSON6) removed. • Section 1 and Section 2 updated. • Table 5: Derating values for P_{tot} total power dissipation updated.			
74AUP1G79 v.6	20120628	Product data sheet	-	74AUP1G79 v.5
Modifications:	• Added type number 74AUP1G79GX (SOT1226) • Package outline drawing of SOT886 (Fig. 13) modified.			
74AUP1G79 v.5	20111128	Product data sheet	-	74AUP1G79 v.4
Modifications:	• Legal pages updated.			
74AUP1G79 v.4	20100720	Product data sheet	-	74AUP1G79 v.3
74AUP1G79 v.3	20090803	Product data sheet	-	74AUP1G79 v.2
74AUP1G79 v.2	20061017	Product data sheet	-	74AUP1G79 v.1
74AUP1G79 v.1	20050912	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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